

# P-Channel 200V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (∧)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
- 200	0.8 at V <sub>GS</sub> = - 10 V	- 1.80	8.0			
	0.9 at $V_{GS} = -6.0 \text{ V}$	- 1.70	0.0			

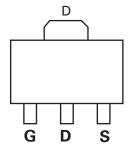
#### **FEATURES**

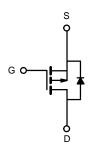
- Halogen-free According to IEC 61249-2-21 Available
- Trench Power MOSFET
- · Ultra Low On-Resistance
- Small Size



#### **APPLICATIONS**

Active Clamp Circuits in DC/DC Power Supplies





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted						
Parameter	Symbol	5 s	Steady State	Unit		
Drain-Source Voltage		V <sub>DS</sub>	- 200		V	
Gate-Source Voltage		V <sub>GS</sub>	± 20			
O	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	- 1.80	- 1.64		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a, b</sup>	T <sub>A</sub> = 70 °C		- 1.70	- 1.51		
Pulsed Drain Current		I <sub>DM</sub>	- 5.5		Α	
Continuous Source Current (Diode Conduction) <sup>a, b</sup>		I <sub>S</sub>	- 1.0	- 0.6		
Single Pulse Avalanche Current	L = 1.0 mH	I <sub>AS</sub>	4.0 1.2			
Single Pulse Avalanche Energy	L = 1.0 mm	E <sub>AS</sub>			mJ	
M · D D · · · · ah	T <sub>A</sub> = 25 °C	- P <sub>D</sub>	1.45	0.95	W	
Maximum Power Dissipation <sup>a, b</sup>	T <sub>A</sub> = 70 °C		0.8	0.48	VV	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maniana basis a Anking	t ≤ 5 s	R <sub>thJA</sub>	75	100	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		120	166	
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	40	50	

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Pulse width limited by maximum junction temperature.



	Symbol		Limits				
Parameter		Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 200			V	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 2.5		- 4.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 200 V, V <sub>GS</sub> = 0 V			- 1	μА	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -15 \text{ V}, V_{GS} = 10 \text{ V}$	- 1.0			Α	
	В	$V_{GS} = -10 \text{ V}, I_D = -0.5 \text{ A}$		0.80			
Drain-Source On-Resistance <sup>a</sup>	R <sub>DS(on)</sub> –	$V_{GS} = -6.0 \text{ V}, I_D = -0.5 \text{ A}$		0.90		^	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 0.5 A		1.8		S	
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = - 1.0 A, V <sub>GS</sub> = 0 V		- 0.85	- 1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg	V <sub>DS</sub> = - 100 V, V <sub>GS</sub> = 10 V		8.0	12	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -100 \text{ V}, V_{GS} = 10 \text{ V}$ $I_{D} \cong -0.5 \text{ A}$		1.3			
Gate-Drain Charge	Q <sub>gd</sub>	.b= 0.0.1		2.5			
Gate Resistance	$R_g$	f = 1.0 MHz		8.0		^	
Input Capacitance	C <sub>iss</sub>			370	510	pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		28			
Reverse Transfer Capacitance	C <sub>rss</sub>			16			
Switching <sup>c</sup>							
Turn-On Time	t <sub>d(on)</sub>	V 400 V D 400		8	12		
Tuili-Oit Tillie	$V_{DD} = -100 \text{ V}, R_L = 100 \text{ A}$ $I_D \cong -1.0 \text{ A}, V_{GEN} = -10 \text{ V}$		11	17	ns		
Turn-Off Time	t <sub>d(off)</sub>			16		25	
Turn-On Time	t <sub>f</sub>	$R_g = 6 \land$		11	17		
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = 0.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		140	200	nC	

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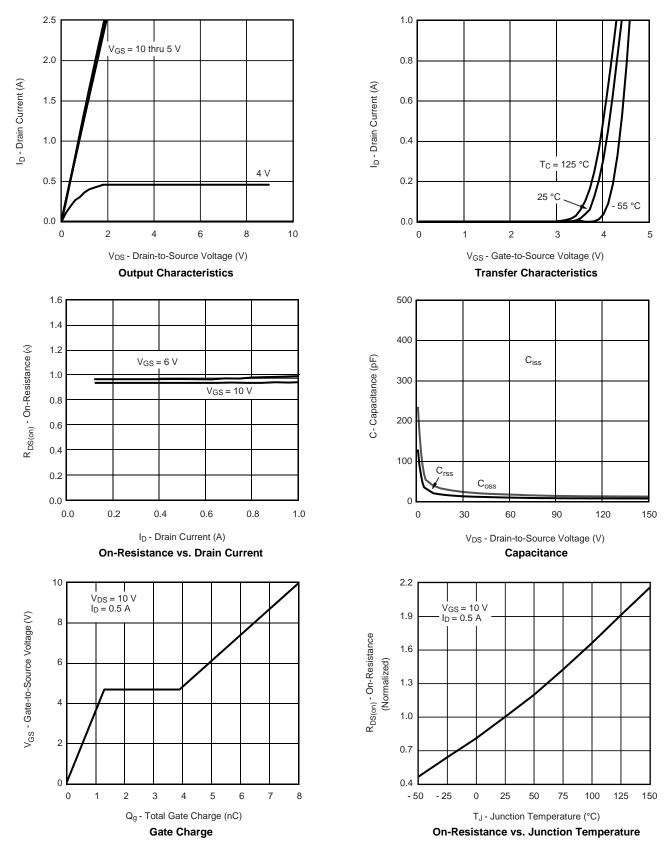
- a. Pulse test: PW  $\leq$  300  $\mu$ s duty cycle  $\leq$  2 %. b. For DESIGN AID ONLY, not subject to production testing. c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



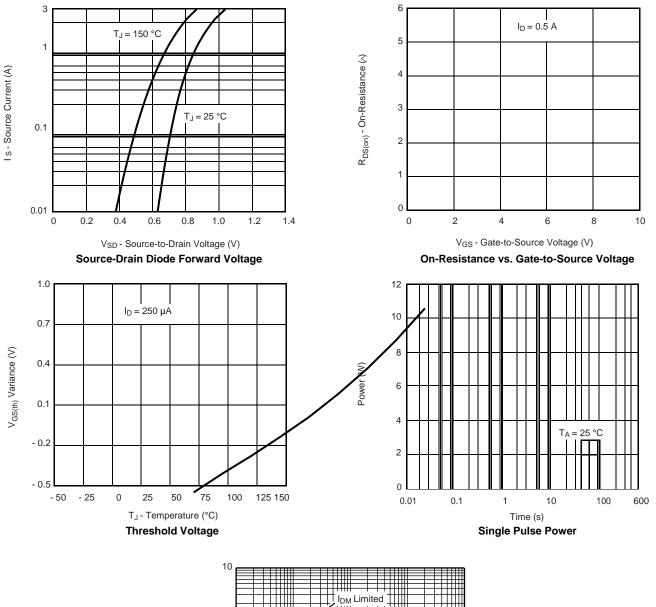
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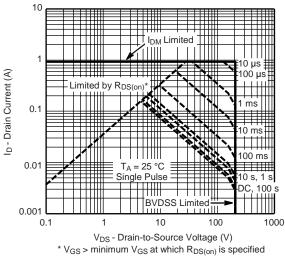
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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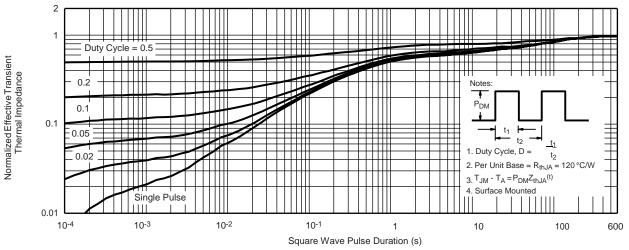




Safe Operating Area



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



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